

Excellent Integrated System Limited

Stocking Distributor

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[FII30-06D](#)

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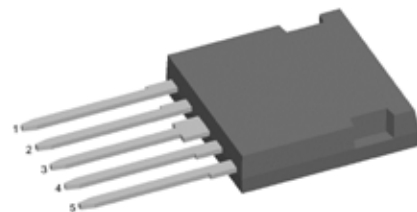
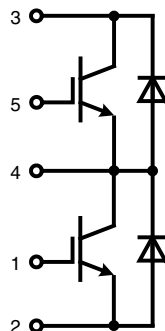
sales@integrated-circuit.com

FII 30-06D

IGBT phaseleg

in ISOPLUS i4-PAC™

$I_{C25} = 30 \text{ A}$
 $V_{CES} = 600 \text{ V}$
 $V_{CE(sat) \text{ typ.}} = 1.9 \text{ V}$



E72873

IGBT			
Symbol	Conditions	Maximum Ratings	
V_{CES}	$T_{VJ} = 25^{\circ}\text{C to } 150^{\circ}\text{C}$	600	V
V_{GES}		± 20	V
I_{C25}	$T_C = 25^{\circ}\text{C}$	30	A
I_{C90}	$T_C = 90^{\circ}\text{C}$	18	A
I_{CM}	$V_{GE} = \pm 15 \text{ V}; R_G = 47 \Omega; T_{VJ} = 125^{\circ}\text{C}$	40	A
V_{CEK}	RBSOA Clamped inductive load; $L = 100 \mu\text{H}$	V_{CES}	
t_{SC} (SCSOA)	$V_{CE} = V_{CES}; V_{GE} = \pm 15 \text{ V}; R_G = 47 \Omega$ $T_{VJ} = 125^{\circ}\text{C}; \text{non-repetitive}$	10	μs
P_{tot}	$T_C = 25^{\circ}\text{C}$	100	W

Features

- NPT IGBT technology
 - low saturation voltage
 - positive temperature coefficient for easy paralleling
 - fast switching
- HiPerFRED™ diode
 - optimized fast and soft reverse recovery
 - low operating forward voltage
 - low leakage current
- ISOPLUS i4-PAC™ package
 - isolated back surface
 - low coupling capacity between pins and heatsink
 - enlarged creepage towards heatsink
 - application friendly pinout
 - low inductive current path
 - high reliability
 - industry standard outline
 - UL registered E 72873

Symbol	Conditions	Characteristic Values			
$(T_{VJ} = 25^{\circ}\text{C}, \text{ unless otherwise specified})$					
		min.	typ.	max.	
$V_{CE(sat)}$	$I_C = 20 \text{ A}; V_{GE} = 15 \text{ V}$		1.9	2.4	V
			2.2		V
$V_{GE(th)}$	$I_C = 0.5 \text{ mA}; V_{GE} = V_{CE}$	4.5		6.5	V
I_{CES}	$V_{CE} = V_{CES}; V_{GE} = 0 \text{ V}$			0.6	mA
			0.6		mA
I_{GES}	$V_{CE} = 0 \text{ V}; V_{GE} = \pm 20 \text{ V}$			200	nA
$t_{d(on)}$	Inductive load $T_{VJ} = 125^{\circ}\text{C}$ $V_{CE} = 300 \text{ V}; I_C = 20 \text{ A}$ $V_{GE} = \pm 15 \text{ V}; R_G = 47 \Omega$		50		ns
t_r			55		ns
$t_{d(off)}$			200		ns
t_f			30		ns
E_{on}			0.75		mJ
E_{off}			0.6		mJ
C_{ies}	$V_{CE} = 25 \text{ V}; V_{GE} = 0 \text{ V}; f = 1 \text{ MHz}$		1.1		nF
Q_{Gon}	$V_{CE} = 300 \text{ V}; V_{GE} = 15 \text{ V}; I_C = 20 \text{ A}$		65		nC
R_{thJC}	with heatsink compound			1.25	K/W
R_{thJH}		2.5		K/W	

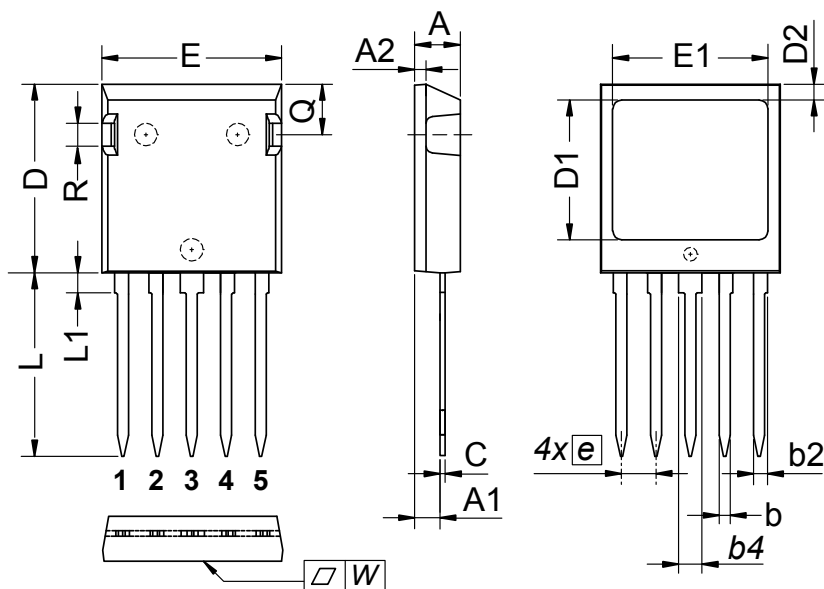
Applications

- single phaseleg
 - buck-boost chopper
- H bridge
 - power supplies
 - induction heating
 - four quadrant DC drives
 - controlled rectifier
- three phase bridge
 - AC drives
 - controlled rectifier

IXYS FII 30-06D

Diode						
Symbol	Conditions			Maximum Ratings		
V_{RRM}	$T_{VJ} = 25^{\circ}\text{C}$ to 150°C			600	V	
I_{F25}	$T_C = 25^{\circ}\text{C}$			30	A	
I_{F90}	$T_C = 90^{\circ}\text{C}$			15	A	
Symbol	Conditions			Characteristic Values		
				min.	typ.	max.
V_F	$I_F = 20\text{ A}$	$T_{VJ} = 25^{\circ}\text{C}$			2.3	2.7
		$T_{VJ} = 125^{\circ}\text{C}$			1.6	
I_{RM}	$I_F = 15\text{ A}; di_F/dt = -400\text{ A}/\mu\text{s};$ $V_R = 300\text{ V}; V_{GE} = 0\text{ V};$	$T_{VJ} = 125^{\circ}\text{C}$			7	A
t_{rr}				50	ns	
R_{thJC}	(per diode)				2.3	K/W
R_{thJH}	with heatsink compound			4.6		K/W

Component						
Symbol	Conditions			Maximum Ratings		
T_{VJ}	operating			-55...+150	$^{\circ}\text{C}$	
T_{stg}				-55...+125	$^{\circ}\text{C}$	
V_{ISOL}	$I_{ISOL} \leq 1\text{ mA}; 50/60\text{ Hz}; t = 1\text{ s}$			2500	V~	
F_C	Mounting force with clip			20...120	Nm	
Symbol	Conditions			Characteristic Values		
				min.	typ.	max.
C_p	coupling capacity between shorted pins and mounting tab in the case				40	pF
d_s, d_A	pin - pin			1.7		mm
d_s, d_A	pin - backside metal			5.5		mm
Weight					6	g

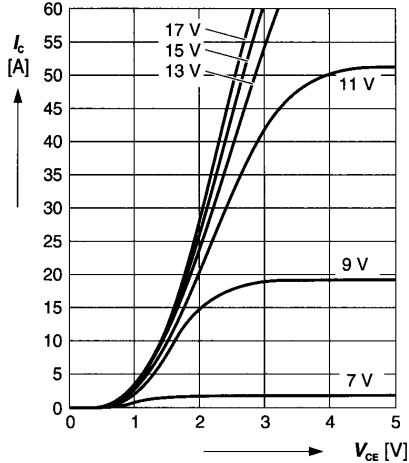


DIM.	MILLIMETER		INCHES	
	MIN	MAX	MIN	MAX
A	4.83	5.21	0.190	0.205
A1	2.59	3.00	0.102	0.118
A2	1.17	2.16	0.046	0.085
b	1.14	1.40	0.045	0.055
b2	1.47	1.73	0.058	0.068
b4	2.54	2.79	0.100	0.110
C	0.51	0.74	0.020	0.029
D	20.80	21.34	0.819	0.840
D1	14.99	15.75	0.590	0.620
D2	1.65	2.03	0.065	0.080
E	19.56	20.29	0.770	0.799
E1	16.76	17.53	0.660	0.690
e	3.81 BSC		0.15 BSC	
L	19.81	21.34	0.780	0.840
L1	2.11	2.59	0.083	0.102
Q	5.33	6.20	0.210	0.244
R	2.54	4.57	0.100	0.180
W	—	0.10	—	0.004

Die konvexe Form des Substrates ist typ. < 0.05 mm über der Kunststoffoberfläche der Bauteilunterseite
 The convex bow of substrate is typ. < 0.05 mm over plastic surface level of device bottom side

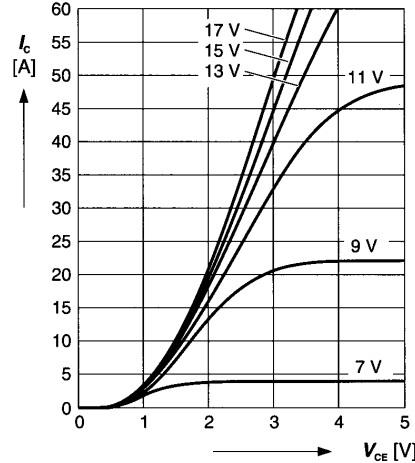
Typ. output characteristics

$I_C = f(V_{CE})$
 parameter: $t_p = 250 \mu s$; $T_j = 25 \text{ }^\circ\text{C}$



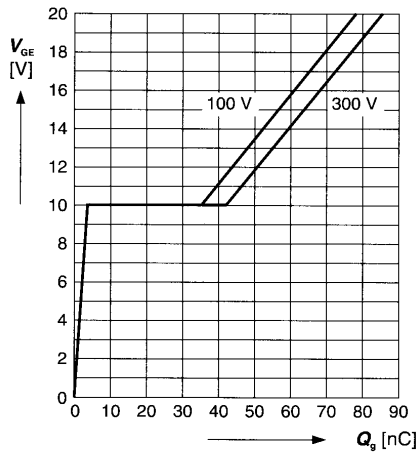
Typ. output characteristics

$I_C = f(V_{CE})$
 parameter: $t_p = 250 \mu s$; $T_j = 125 \text{ }^\circ\text{C}$



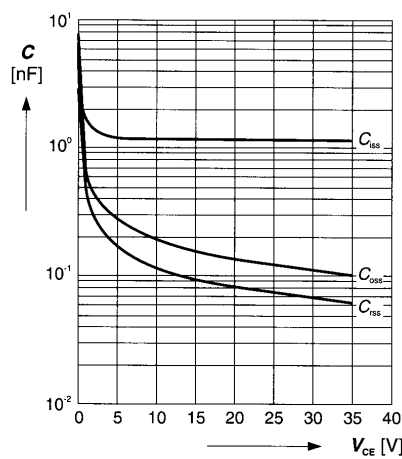
Typ. gate charge

$V_{GE} = f(Q_g)$
 parameter: $I_{C \text{ puls}} = 20 \text{ A}$



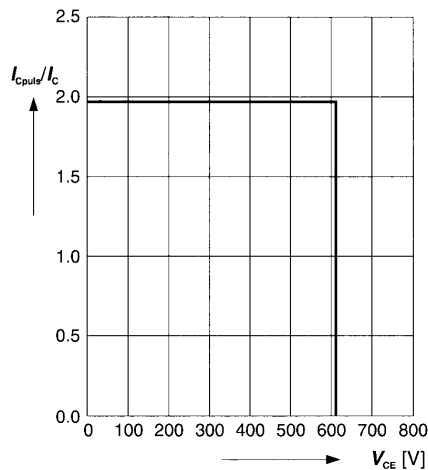
Typ. capacitances

$C = f(V_{CE})$
 parameter: $V_{GE} = 0 \text{ V}$; $f = 1 \text{ MHz}$



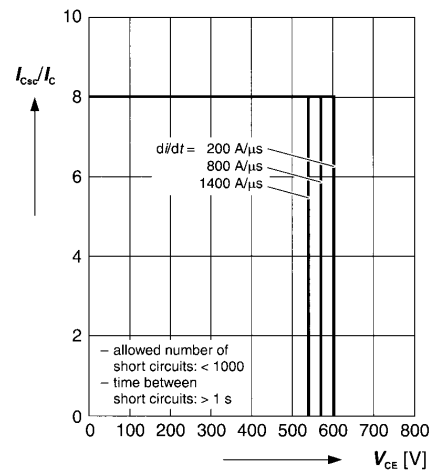
Reverse biased safe operating area

$I_{C \text{ puls}} = f(V_{CE})$, $T_j = 150 \text{ }^\circ\text{C}$
 parameter: $V_{GE} = 15 \text{ V}$



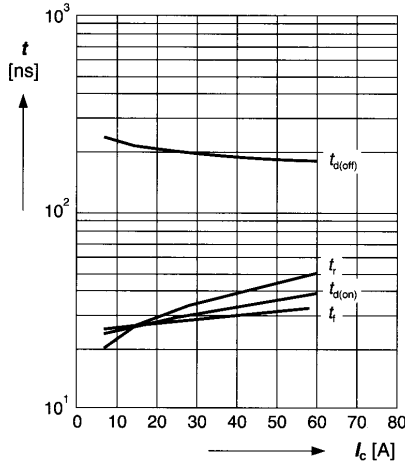
Short circuit safe operating area

$I_{C \text{ sc}} = f(V_{CE})$, $T_j = 150 \text{ }^\circ\text{C}$
 parameter: $V_{GE} = \pm 15 \text{ V}$; $t_{sc} \leq 10 \mu s$; $L < 50 \text{ nH}$



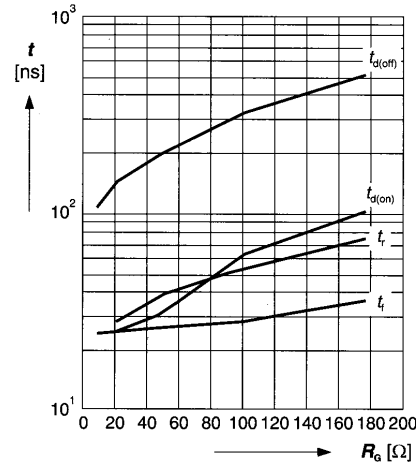
Typ. switching time

$t = f(I_C)$, inductive load, $T_j = 125\text{ }^\circ\text{C}$
 parameter: $V_{CE} = 300\text{ V}$; $V_{GE} = \pm 15\text{ V}$; $R_G = 33\text{ }\Omega$



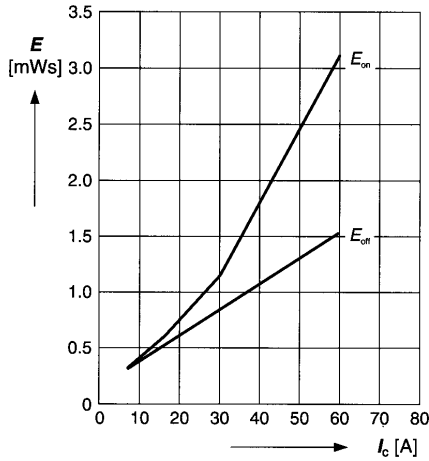
Typ. switching time

$t = f(R_G)$, inductive load, $T_j = 125\text{ }^\circ\text{C}$
 parameter: $V_{CE} = 300\text{ V}$; $V_{GE} = \pm 15\text{ V}$; $I_C = 30\text{ A}$



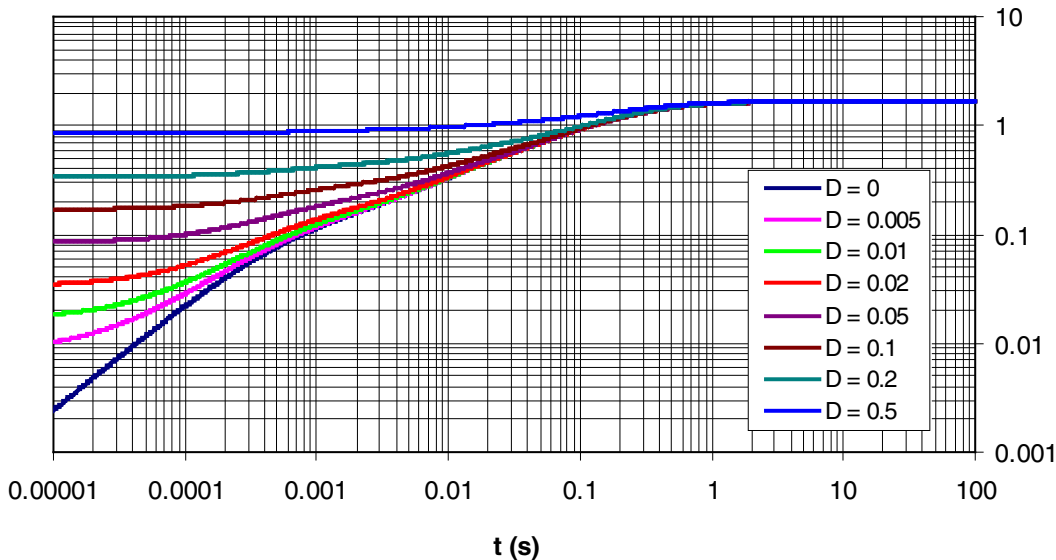
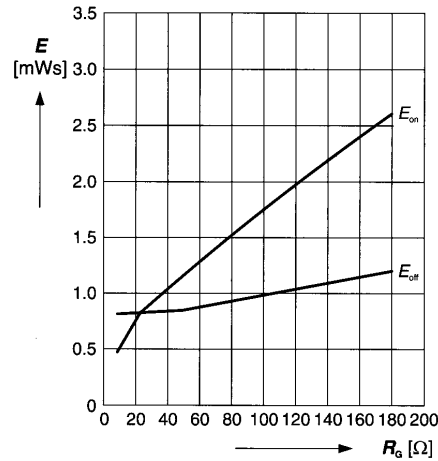
Typ. switching losses

$E = f(I_C)$, inductive load, $T_j = 125\text{ }^\circ\text{C}$
 parameter: $V_{CE} = 300\text{ V}$; $V_{GE} = \pm 15\text{ V}$; $R_G = 33\text{ }\Omega$



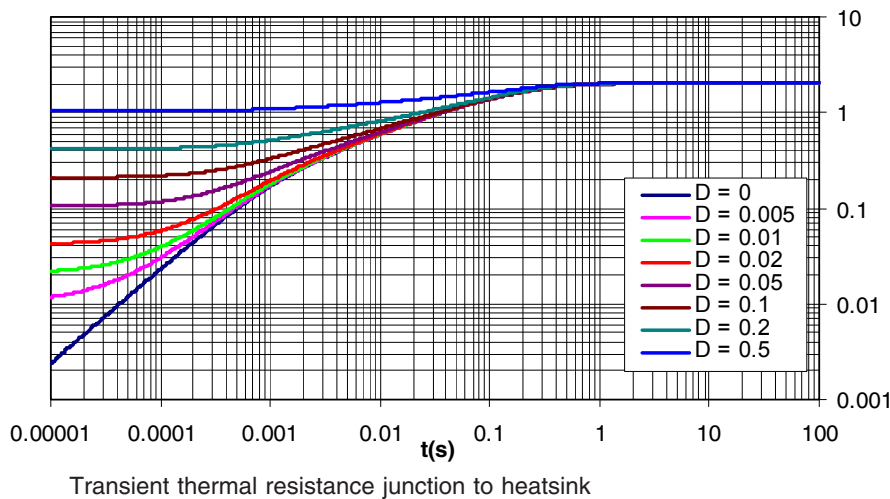
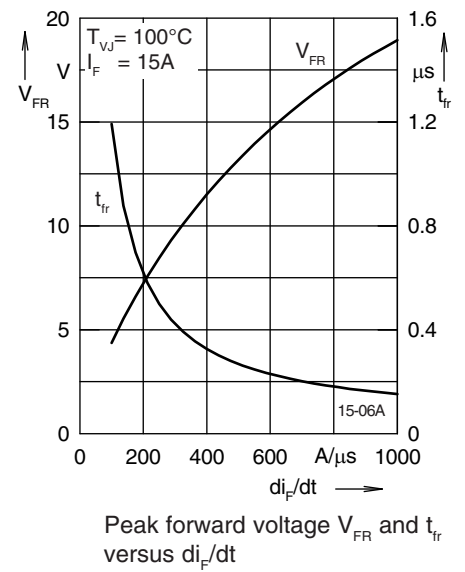
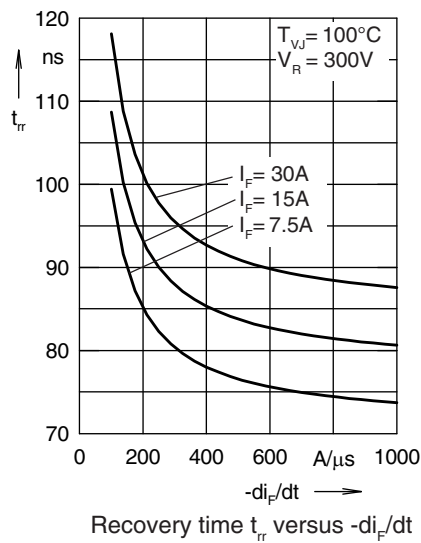
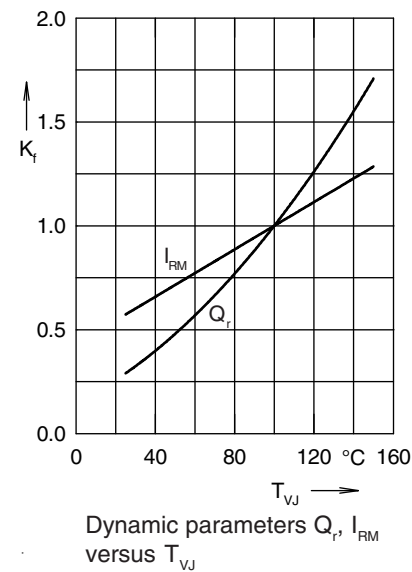
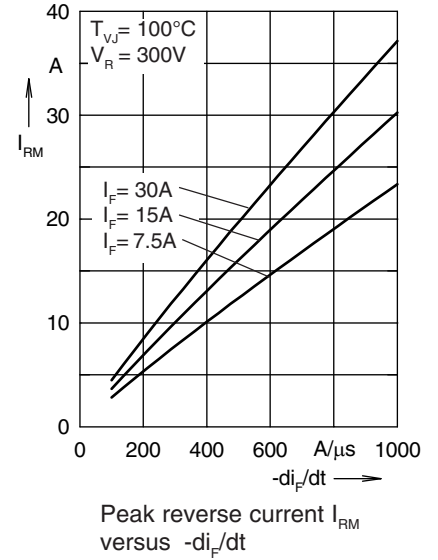
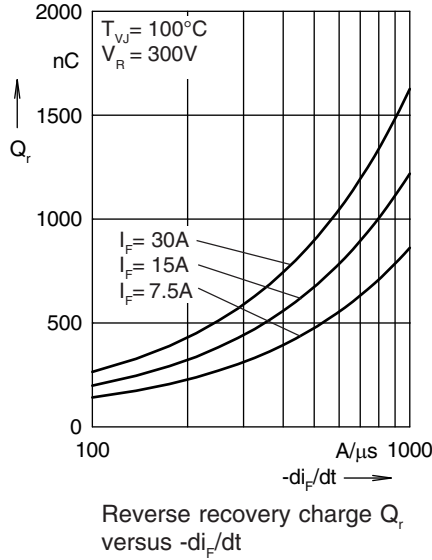
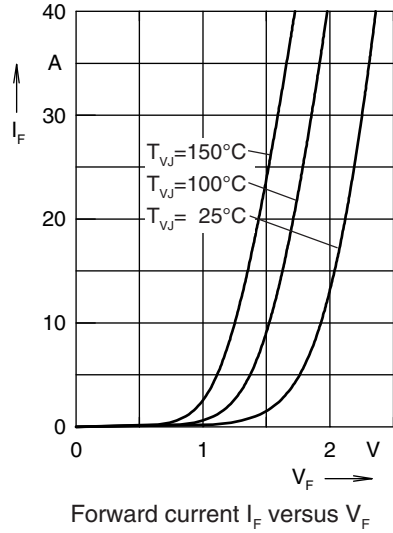
Typ. switching losses

$E = f(R_G)$, inductive load, $T_j = 125\text{ }^\circ\text{C}$
 parameter: $V_{CE} = 300\text{ V}$; $V_{GE} = \pm 15\text{ V}$; $I_C = 30\text{ A}$



IXYS **FII 30-06D**

Diode



FRED
 $Z_{thjH} [K/W]$